

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. 09/518,511
Priority Filing Date March 3, 2000
Inventor Dinesh Chopra, et al
Assignee Micron Technology, Inc.
Priority Group Art Unit 2825
Priority Examiner L. Malsawma
Attorney's Docket No. MI22-1747
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods, and
Integrated Circuits Formed Thereby

PRELIMINARY AMENDMENT

To: Box Patent Application
Assistant Commissioner for Patents
Washington, D.C. 20231

From: James E. Lake (Tel. 509-624-4276; Fax 509-838-3424)
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AMENDMENTS

In the Specification

At p. 1, before the "Technical Field" section, insert

--RELATED PATENT DATA

This patent resulted from a divisional application of U.S. Patent
Application Serial No. 09/518,511, filed on March 3, 2000.--

In the Claims

Cancel claims 1-46 without prejudice.

EL 844046847


REMARKS

Claims 1-46 are cancelled. Claims 47-54 are pending in the application.

Examination of claims 47-54 is requested.

Respectfully submitted,

Dated: 13 Jun 2001

By: 
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